Vishay General Semiconductor

Glass Passivated Ultrafast Plastic Rectifier



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PRIMARY CHARACTERISTICS					
I _{F(AV)}	1.0 A				
V _{RRM}	800 V, 1000 V				
I _{FSM}	30 A				
t _{rr}	75 ns				
V _F at I _F	1.3 V				
T _J max.	175 °C				
Package	DO-204AC (DO-15)				
Diode variation	Single die				

FEATURES

- Superectifier structure for high reliability condition
- · Cavity-free glass passivated pellet chip junction
- Ultrafast reverse recovery time
- Low forward voltage drop
- Low switching losses, high efficiency
- · High forward surge capability
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer and telecommunication.

MECHANICAL DATA

Case: DO-204AC, molded epoxy over glass body Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	BYV26DGP	BYV26EGP	UNIT		
Maximum repetitive peak reverse voltage	V _{RRM}	800	1000	V		
Maximum RMS voltage	V _{RMS}	560	700	V		
Maximum DC blocking voltage	V _{DC}	800	1000	V		
Maximum average forward rectified current 0.375" (9.5 mm) lead length (fig. 1)	I _{F(AV)}	1.0		А		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	30		А		
Non repetitive peak reverse energy	E _{RSM} ⁽¹⁾	10		mJ		
Operating junction and storage temperature range	T _J , T _{STG}	-65 to +175		°C		

Note

⁽¹⁾ Peak reverse energy measured at $I_R = 400$ mA, $T_J = T_J$ max. on inductive load, t = 20 µs





COMPLIANT



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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	BYV26DGP	BYV26EGP	UNIT	
Minimum avalanche breakdown voltage	100 µA		V _{BR}	900	1100	V	
Maximum instantaneous forward voltage	1.0 A	T _J = 25 °C	V _F	2.5		v	
		T _J = 175 °C		1.	.3	v	
Maximum DC reverse current at rated DC		T _A = 25 °C	- I _R	5.	.0		
blocking voltage		T _A = 165 °C		150		μΑ	
Max. reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	75		ns	
Typical junction capacitance	4.0 V, 1 MHz		CJ	15		pF	

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	BYV26DGP	BYV26EGP	UNIT		
Typical thermal resistance		70		°C/W		
	R _{0JL} ⁽²⁾	16		C/W		

Notes

(1) Thermal resistance from junction to ambient at 0.375" (9.5 mm) lead length, mounted on PCB with 0.5" x 0.5" (12 mm x 12 mm) copper pads

⁽²⁾ Thermal resistance from junction to lead at 0.375" (9.5 mm) lead length with both leads attached to heatsink

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
BYV26EGP-E3/54	0.428	54	4000	13" diameter paper tape and reel		
BYV26EGP-E3/73	0.428	73	2000	Ammo pack packaging		



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

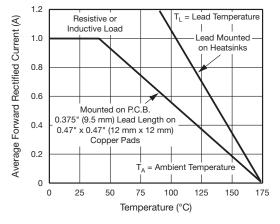


Fig. 1 - Maximum Forward Current Derating Curve

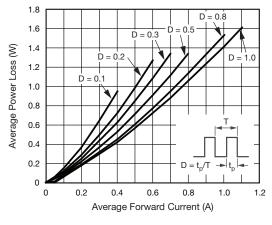


Fig. 2 - Forward Power Loss Characteristics

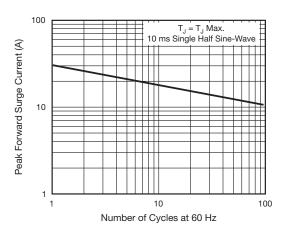


Fig. 3 - Maximum Non-Repetitive Peak Forward Surge Current

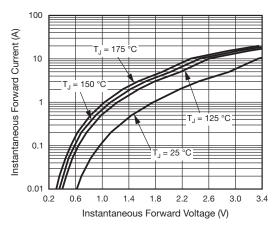


Fig. 4 - Typical Instantaneous Forward Voltage Characteristics

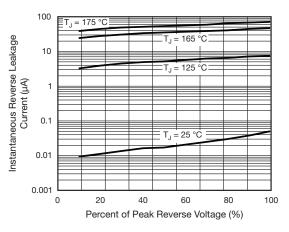


Fig. 5 - Typical Reverse Leakage Characteristics

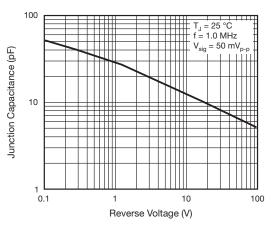


Fig. 6 - Typical Junction Capacitance

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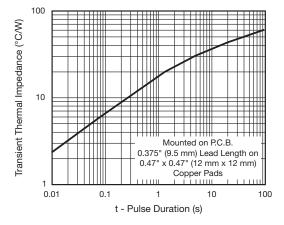
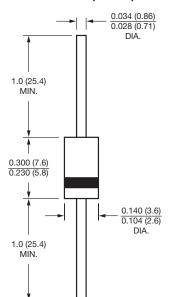


Fig. 7 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



DO-204AC (DO-15)



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